## Special Issue

## Augmented and Virtual Reality for Smart Applications

## Message from the Guest Editor

This Special Issue explores the transformative potential of Augmented Reality (AR) and Virtual Reality (VR) for developing intelligent, innovative solutions across diverse domains. We seek to highlight cutting-edge research, novel methodologies, and practical applications that leverage AR/VR to create more immersive, interactive, and efficient systems for real-world challenges. Topics of interest include:

- Advanced HCI within AR/VR environments.
- Al Integration with AR/VR for enhanced user experiences.
- Hardware/Software Advancements for smart AR/VR applications.
- Controlling Embodied Agents in virtual environments.
- Innovative Building & Rendering of AR/VR environments.
- Interactive Simulations for diverse applications.
- Domain Applications: Education, Healthcare, Manufacturing, Entertainment, Smart Urban Planning.

We welcome original research, comprehensive review articles, and insightful case studies demonstrating the evolving contributions of AR/VR to smart, impactful applications.

### **Guest Editor**

Dr. Kang Hoon Lee

Department of Computer Science, Kwangwoon University, 447-1, Wolgye-Dong, Nowon-Gu, Seoul 139-701, Republic of Korea

## Deadline for manuscript submissions

20 February 2026



# Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



mdpi.com/si/248415

Applied Sciences Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41616837734 applsci@mdbi.com

mdpi.com/journal/applsci





## Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



## **About the Journal**

## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

## Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

### **Author Benefits**

## **Open Access:**

free for readers, with article processing charges (APC) paid by authors or their institutions.

### **High Visibility:**

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, CAPlus / SciFinder, and other databases.

#### Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

